

SMF3.3





Agency Approvals

| AGENCY | AGENCY FILE NUMBER |
|-------------|--------------------|
| 71 ° | E230531 |

Maximum Ratings and Thermal Characteristics (T_a=25°C unless otherwise noted)

| Parameter | | Symbol | Value | Unit |
|--|--------------------|------------------|------------|------|
| Peak Pulse Power | 8/20µs | D | 1200 | W |
| Dissipation at T _A =25°C (Note 1) | 10/1000µs | P _{PPM} | 200 | W |
| Thermal Resistance Ambient | $R_{_{\theta JA}}$ | 220 | °C/W | |
| Thermal Resistanc | $R_{\theta JL}$ | 100 | °C/W | |
| Operating Tempera | T _J | -55 to 150 | °C | |
| Storage Temperatu | ire Range | T_{STG} | -55 to 150 | °C |

Notes:

1. Non-repetitive current pulse, per Fig. 4 & 6 and derated above $T_{_{\rm J}}$ (initial) =25°C per Fig. 3.

Description

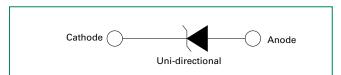
SMF3.3 is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

Features

- 200W peak pulse power capability at 10/1000µs waveform, repetition rate (duty cycle): 0.01%
- 1200W peak pulse power capability at 8/20us waveform
- Excellent clamping capability
- Compatible with industrial standard package SOD-123FL
- Low profile: maximum height of 1.08mm.
- For surface mounted applications to optimize board space
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- IEC-61000-4-2 ESD 30kV(Air), 30kV (Contact)

- ESD protection of data lines in accordance with IEC 61000-4-2
- EFT protection of data lines in accordance with IEC 61000-4-4
- Fast response time: typically less than 1.0ns from 0 Volts to V_{BB} min
- High temperature soldering: 260°C/40 seconds at terminals
- Built-in strain relief
- Meet MSL level1, per J-STD-020C, LF maximun peak of 260°C
- Matte tin lead-free plated
- Halogen-free and RoHS compliant
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/ JEDEC J-STD-609A.01)

Functional Diagram



Applications

SMF3.3 devices are ideal for the protection of portable devices/hard drives, notebooks, $V_{\rm CC}$ busses, POS terminal, SSDs, power supplies, monitors, and vulnerable circuit used in other consumer applications.

Electrical Characteristics (T_a=25°C unless otherwise noted)

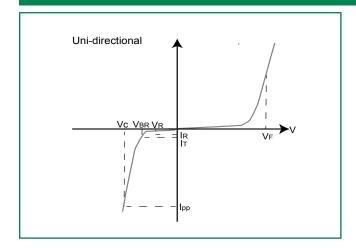
| Part Number | Marking Code | Voltaç | akdown Test current | Reverse Stand off Voltage V _R | Maximum Reverse Leakage @ V。 | Maximum Peak Pulse Current | Maximum Clamping Voltage @l _{oo} | Maximum Peak Pulse Current | Maximum Clamping Voltage @l _{oo} | | |
|----------------|-----------------|--------|---------------------|--|------------------------------------|----------------------------------|---|-----------------------------------|---|----------|------|
| | | MIN | MAX | (mA) | (V) | | (10/1000µS) I _{pp} (A) | (10/1000µS) V _c (V) | (8/20µS) I _{pp} (A) | (8/20µS) | |
| SI | VVE3 3 | 33 | 3.4 | 13 | 10 | 3.3 | 0.5 | 30.0 | 6.8 | 120.0 | 10.0 |

Notes:

- 1. V_{gR} measured after I_{T} applied for 300µs, I_{T} = sequare wave pulse or equivalent.
- 2. Surge current waveform per 10/1000µs exponential wave and derated per Fig.2.
- 3. All terms and symbols are consistent with ANSI/IEEE C62.35.
- 4. Surge current waveform per 8/20µs exponential wave and derated per Fig.6.



I-V Curve Characteristics



- $\mathbf{P}_{\scriptscriptstyle{\mathbf{PPM}}}$ Peak Pulse Power Dissipation Max power dissipation
- V_{BR} **Breakdown Voltage** -- Maximum voltage that flows though the TVS at a specified test current (I_{γ})
- V_c Clamping Voltage Peak voltage measured across the TVS at a specified Ippm (peak impulse current)
- ${f I}_{_{R}}$ Reverse Leakage Current -- Current measured at ${f V}_{_{R}}$
- Forward Voltage Drop for Uni-directional

note: V_F distribution range from 10V to 15V

Ratings and Characteristic Curves (T_A=25°C unless otherwise noted)

Figure 1 - TVS Transients Clamping Waveform

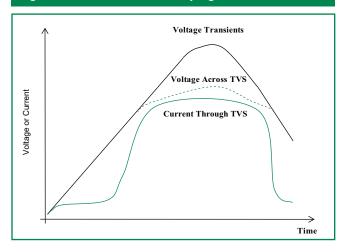


Figure 2 - Peak Pulse Power Rating Curve

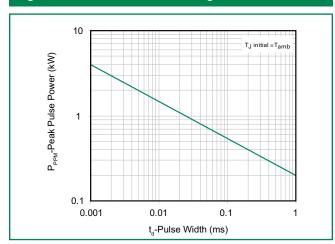


Figure 3 - Peak Pulse Power Derating Curve

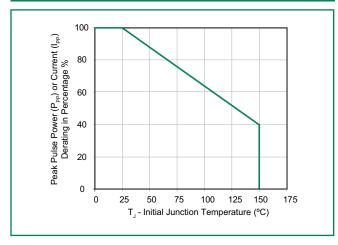
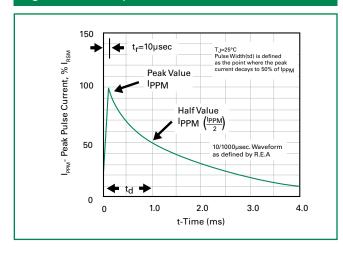


Figure 4 - 10/1000µS Pulse Waveform



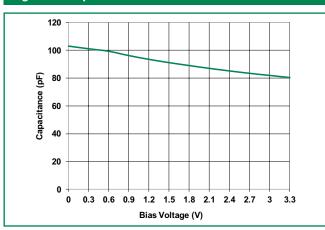
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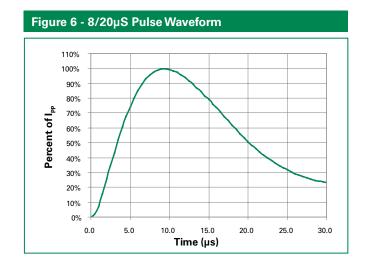
Specifications are subject to change without notice.

Revised: 07/28/16



Figure 5 - Capacitance vs. Reverse Bias



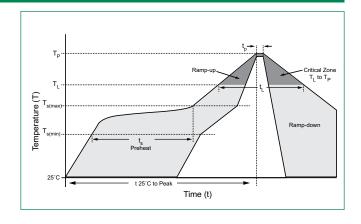


Soldering Parameters

| Reflow Co | ndition | Lead-free assembly | |
|-------------------------|--|-------------------------|--|
| | -Temperature Min (T _{s(min)}) | 150°C | |
| Pre Heat | -Temperature Max (T _{s(max)}) | 200°C | |
| | -Time (min to max) (t _s) | 60 – 180 secs | |
| Average ra to peak | mp up rate (Liquidus Temp (T _A) | 3°C/second max | |
| $T_{S(max)}$ to T_A | - Ramp-up Rate | 3°C/second max | |
| Reflow | -Temperature (T _A) (Liquidus) | 217°C | |
| nellow | -Time (min to max) (t _s) | 60 – 150 seconds | |
| Peak Temp | erature (T _P) | 260 ^{+0/-5} °C | |
| Time withi Temperatu | n 5°C of actual peak re (t _p) | 20 – 40 seconds | |
| Ramp-dow | n Rate | 6°C/second max | |
| Time 25°C | to peak Temperature (T _P) | 8 minutes Max. | |
| Do not exc | eed | 260°C | |



| Case | SOD-123FL plastic over passivated junction | | |
|----------|--|--|--|
| Polarity | Color band denotes cathode except bipola | | |
| Terminal | Matte tin-plated leads, solderable per JESD22-B102 | | |

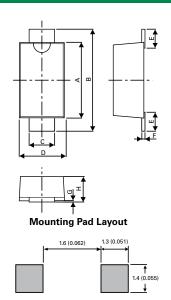


High Reliability Test Specification

| Pre-condition (HTRB/TC/ PCT/ H3TRB) | (1) Bake 24hrs @150°C (2)168hrs @85% RH and 85°C (3) I _R reflow,3 reflows, peak temperature of 260°C |
|---|--|
| HTRB | JESD 22-108C $V_{\rm CC}$ bias= 80% $V_{\rm DRM}$ & $T_{\rm A}$ =150°C, 1008hrs |
| Temperature Cycling | MIL-STD-883F, Method 1010.8 Condition C -65°C to150°C, 1000 cycles |
| Pressure Cooker | JEDEC 22-A102C 100%RH @121°C @15psi, 96hrs |
| Bias Humidity (H3TRB) | JESD 22-A101B Vcc bias (pin1to pin3)=V _{DRM} ,85%RH, 85°C , 1008 hours |
| RSH | JESD 22-A111 260°C ,10 secs. |

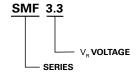


Dimensions - SOD-123FL Package

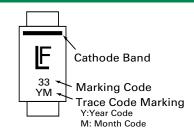


| Dimensions | Millim | neters | Inches | | |
|------------|--------|--------|--------|-------|--|
| Dimensions | Min | Max | Min | Max | |
| А | 2.90 | 3.10 | 0.114 | 0.122 | |
| В | 3.50 | 3.90 | 0.138 | 0.154 | |
| С | 0.85 | 1.05 | 0.033 | 0.041 | |
| D | 1.70 | 2.00 | 0.067 | 0.079 | |
| Е | 0.43 | 0.83 | 0.017 | 0.033 | |
| F | 0.10 | 0.25 | 0.004 | 0.010 | |
| G | 0.00 | 0.10 | 0.000 | 0.004 | |
| Н | 0.90 | 1.08 | 0.035 | 0.043 | |

Part Numbering System



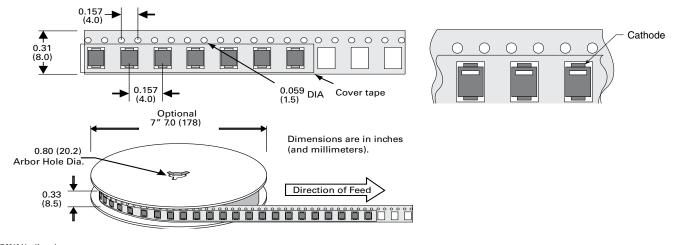
Part Marking System



Packaging Options

| Part number | Component Package | Quantity | Packaging Option | Packaging Specification |
|-------------|----------------------|----------|--------------------------------|----------------------------|
| SMF3.3 | SOD-123FL | 3000 | Tape & Reel – 8mm tape/7" reel | EIA RS-481 |

Tape and Reel Specification



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